

WTXS0104E 4-Bit Bidirectional Voltage-Level Translator

Description

This 4-bit non-inverting translator is a bidirectional voltage-level translator and can be used to build digital switching compatibility between multi voltage systems. It uses two separate configurable power supply rails that including A ports supporting operating voltages from 1.65 V to 3.6 V with tracking V_{CCA} supply, and also including B ports supporting operating voltages from 2.3 V to 5.5 V with tracking V_{CCB} supply.

The advantage above provides the support of both lower and higher logic signal levels while providing bidirectional translation capabilities between any of the 1.8-V, 2.5-V, 3.3-V, and 5- V voltage circuit points.

Placing output-enable (OE) input to low level, all I/Os are forced to high-impedance state that significantly lower the quiescent current consumption. In order to ensure the high-impedance state during power up or power down, OE pin should be tied to GND via a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

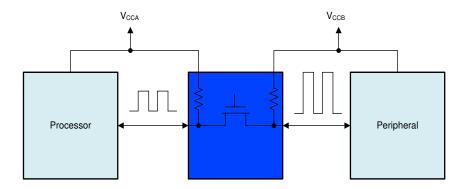
Features

- No direction -control
- Data rates
- 24 Mbps (Push Pull)
- 2 Mbps (Open Drain)
- 1.65 V to 3.6 V on A port and 2.3 V to 5.5 V on B port ($V_{CCA} \le V_{CCB}$)
- VCC isolation feature: If either VCC input is at GND, both ports are in the high -impedance state
- No power -supply sequencing required: either V CCA or V CCB can be ramped first
- loff supports partial -power -down mode operation
- Operating temperature range: -40°C to +85°C

Applications

- Handset/Smartphone
- MART
- IPC
- GPIO

Circuit Diagram



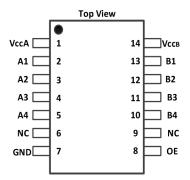


Order information

Package	Orderable Device	PackingQty	Body Size	Marking
SOP-14	WTXS0104EDR	Tape and Reel,2500	8.65mm x 6.00mm	WTXS0104E
TSSOP-14	WTXS0104EPWR	Tape and Reel,2000	5.00mm x 4.40mm	WTXS0104E
QFN3.5*3.5-14L	WTXS0104ERGYR	Tape and Reel,3000	3.50mm x 3.50mm	WTXS0104E

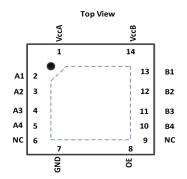
Device Summary, Pin and Packages





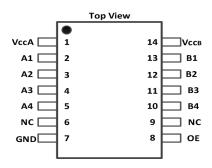
WTXS0104E : DR (SOP-14) Package





WTXS0104E: RGYR (SOP-14) Package





WTXS0104E : EPWR(SOP-14) Package



Device Summary, Pin and Packages (Continued)

		Pin		1/0		
Name	RGY	D	PW	I/O	Function	
Vcca	1	1	1	-	Port Supply Voltage. 1.65V≤VccA≤3.6V and VccA≤VccB	
A1	2	2	2	I/O	Input/Output A1. Referenced to V _{CCA} .	
A2	3	3	3	I/O	Input/Output A2. Referenced to V _{CCA} .	
A3	4	4	4	I/O	Input/Output A3. Referenced to V _{CCA} .	
A4	5	5	5	I/O	Input/Output A4. Referenced to V _{CCA} .	
NC	6	6	6	-	No internal connection	
GND	7	7	7	-	Ground	
OE	8	8	8	I	Output Enable(Active High).Pull OE low to place all outputs in 3-state mode. Referenced to V _{CCA} .	
NC	9	9	9	-	No internal connection	
B4	10	10	10	I/O	Input/Output B4. Referenced to V _{CCB} .	
B3	11	11	11	I/O	Input/Output B3. Referenced to V _{CCB} .	
B2	12	12	12	I/O	Input/Output B2. Referenced to V _{CCB} .	
B1	13	13	13	I/O	Input/Output B1. Referenced to V _{CCB} .	
V _{CCB}	14	14	14	-	B Port Supply Voltage. 2.3V≤VccB≤5.5V	

Absolute Maximum Ratings

Parameters		Min	Max	Unit
Supply voltage, Vcca	Supply voltage, Vcca			
Supply voltage, Vccв		-0.3	6.0	V
land on the manner M	Input voltage range V			
Input voltage range,V _I	B port	-0.3	6.0	V
Voltage range applied to any output in the high-impedance or	A port	-0.3	6.0	W
power-off state, Vo	B port	-0.3	6.0	V
Valtage range applied to any output in the high or law state. Va	A port	-0.3	V _{CCA} +0.3	V
Voltage range applied to any output in the high or low state, Vo	B port	-0.3	V _{CCA} +0.3	V
Input clamp current, I _{IK}	V _I <0		-50	mA
Output clamp current, l _{OK}	V ₀ <0		-50	mA
Continuous output current, lo			±50	mA
Continuous current through Vcca, VccB or GND				
Maximum junction temperature			150	°C
Storage temperature range		-65	150	°C

⁽¹⁾Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

ESD Ratings

	E	Value	Unit	
\//ECD\	Clastrostatia Disabarra	Human-Body Model (HBM) ⁽¹⁾	±3K	V
V(ESD)	Electrostatic Discharge	Charged-Device Model (CDM)(2)	±2K	V

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed

⁽³⁾ The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



Recommended Operating Conditions

Vccı is the supply voltage associated with the input port. Vcco is the supply Voltage associated with the output port.

Parameter		Conditions	Min Ty		Max	Unit	
Supply voltage ⁽¹⁾	V_{CCA}		1.65		3.6	V	
Supply voltage \		V_{CCB}	2.3		5.5	V	
	A port I/Os	V _{CCA} =1.65 V to 1.95 V V _{CCB} =2.3 V to 5.5 V	V _{CCI} -0.2		Vccı		
Lligh lovel	A-port I/Os	V _{CCA} =2.3 V to 3.6 V V _{CCB} =2.3 V to 5.5 V	V _{CCI} -0.4		Vccı		
High-level input voltage(V _{IH})	ut B-port I/Os Vo	V _{CCA} =1.65 V to 3.6V V _{CCB} =2.3 V to 5.5 V	V _{CCI} -0.4		V	V	
	OE input	V _{CCA} =1.65 V to 3.6 V V _{CCB} =2.3 V to 5.5 V	V _{CCI} ×0.8		5.5		
Low-level	A-port I/Os	V _{CCA} =1.65 V to 1.95 V V _{CCB} =2.3 V to 5.5 V	0		0.15	V	
input voltage(VIL) ⁽²⁾	B-port I/Os	V _{CCA} =1.65 V to 3.6 V V _{CCB} =2.3 V to 5.5 V	0		0.15	V	
OE	OE input	V _{CCA} =1.65 V to 3.6 V V _{CCB} =2.3 V to 5.5 V	0		V _{CCA} ×0.25	V	
Input transition rise	A-port I/Os	push-pull driving			10		
Input transition rise or fall rate(Δt/Δv)	B-port I/Os push-pull driving				10	ns/V	
οι ιαπιαιε(Δι/Δν)	Control input				10		
TA Operating free- air temperature	-		-40		85	°C	

⁽¹⁾ V_{CCA} must be less than or equal to V_{CCB}.

⁽²⁾ The maximum V_{IL} value is provided to ensure that a valid V_{OL} is maintained. The V_{OL} value is V_{IL} plus the voltage drop across the pass gate transistor.



Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (1) (2) (3)

Parameter		meter Conditions VccA		Vccв	Temp	Temp Min Typ Max			Uni	
Voha	Port A Output High Voltage	I _{OH} =−20 μA V _{IB} ≥ V _{CCB} − 0.4V	1.65V to 3.6V	2.3V to 5.5V	Full	V _{CCA} ×0.7			V	
Vola	Port A Output Low Voltage	I _{OL} =1mA V _{IB} ≤ 0.15 V	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V	
V _{OHB}	Port B Output High Voltage	I _{OH} =−20 μA V _{IA} ≥ V _{CCA} − 0.4V	1.65V to 3.6V	2.3V to 5.5V	Full	V _{CCA} ×0.7			V	
Volb	Port B Output Low Voltage	I_{OL} =1mA $V_{IA} \le 0.15 \text{ V}$	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V	
l _l	Input Leakage	OE	1.65V to 3.6V	2.3V to 5.5V	+25℃			±1	μ/	
П	Current	OL	1.000 to 3.00	2.57 to 5.57	Full			±1.5	μ	
		A Ports	0V	0V to 5.5V	+25℃			±0.5		
Partial Power	Power	AT OILS	00	0 10 0.01	Full			±1	114	
IOII	Down Current		B Ports	0V to 3.6V 0V	0V	+25℃			±0.5	μΑ
		D T GILO	0 10 0.01	00	Full			±1		
loz	High-impedance State Output	A or B port	1.65V to 3.6V	2.3V to 5.5V	+25℃			±0.5	±0.5 μA	
IOZ	Current	OE=ÖV	OE=0V	2.00 to 0.00	Full			±1	μ	
			1.65V to V _{CCB}	2.3v to 5.5V	Full			2.5		
Icca	V _{CCA} Supply Current	V₁=V₀=open I₀=0	3.6v	0V	Full			2.5	μ	
			0v	5.5V	Full			-1		
			1.65V to V _{CCB}	2.3v to 5.5V	Full			10		
Icca	V _{CCB} Supply Current	V⊨V _O =open I _O =0	3.6v	0V	Full			-1	μ	
			0v	5.5V	Full			1		
CCA + ICCB	Combined Supply Current	V _I =V _{CCI} or GND I _{O=} 0	1.65V to V _{CCB}	2.3v to 5.5V	Full			13	μΑ	
Iccza	V _{CCA} Supply Current	V _I =V _{CCI} or 0V I ₀ =0, OE=0V	1.65V to V _{CCB}	2.3v to 5.5V	Full			1	μ/	
I _{CCZB}	V _{CCB} Supply Current	V _I =V _{CCI} or 0V I _O =0, OE=0V	2.3v to 3.6V	2.3v to 5.5V	Full			1	μΑ	
Ci	Input Capacitance	OE	3.3V	3.3V	+25 ℃		2.5		Pf	
Cio	Input-to-output Internal	A Port	3.3V	3.3V	+25℃		5		DI	
Cio	Capacitance	B Port	3.3V	3.3V	+25℃	5			- PF	

⁽¹⁾ V_{CCI} is the VCC associated with the input port.

⁽²⁾ $V_{\text{\tiny CCO}}$ is the VCC associated with the output port

⁽³⁾ V_{CCA} must be less than or equal to V_{CCB} .



Timing Requirements

V_{CCA} =1.8 $V\pm0.15V$

		V_{CCB} =2.5 V \pm 0.2 V	V _{CCB} =3.3V±0.2V	V _{CCB} =5V±0.2V	Unit
		Тур	Тур	Тур	UIII
Data Rate	Push-pull Driving	21	22	24	Mhna
Data Rate	Open-drain Driving	2	2	2	Mbps
Pulse	Push-pull Driving (Data Inputs)	47	45	41	
Duration(tw)	Open-drain Driving (Data Inputs)	500	500	500	ns

$V_{CCA}=2.5V\pm0.15V$

		V _{CCB} =2.5V±0.2V	V _{CCB} =3.3V±0.2V	V _{CCB} =5V±0.2V	Unit
		Тур	Тур	Тур	Unit
Data Rate	Push-pull Driving	20	22	24	Mbps
Data Nate	Open-drain Driving	2	2	2	IVIDPS
Pulse	Push-pull Driving (Data Inputs)	50	45	41	no
Duration(tw)	Open-drain Driving (Data Inputs)	500	500	500	ns

V_{CCA} =3.3 $V\pm0.15V$

		V _{CCB} =3.3V±0.2V	V _{CCB} =5V±0.2V	Unit
		Тур	Тур	UIIIL
Data Rate	Push-pull Driving	23	24	Mbps
Data Nate	Open-drain Driving	2	2	IVIDPS
Pulse Duration(tw)	Push-pull Driving (Data Inputs)	43	41	ns
r dise Duration(tw)	Open-drain Driving (Data Inputs)	500	500	113



Switching Characteristics:Vcc=1.8V±0.15V

over recommended operating free-air temperature range (unless otherwise noted)

	Donomotor		Conditions	V _{ccB} =2.5V±0.2V	V _{ccB} =3.3V±0.2V	V _{ccB} =5V±0.2V	Units	
	Parameter		Conditions	Тур	Тур	Тур	Units	
tрнL	Propagation Delay Time	A to B	Push-pull Driving	5.6	5	5	ns	
412	High-to-low Output	7110 2	Open-drain Driving	7.5	7.9	8.3		
t	Propagation Delay Time	A to B	Push-pull Driving	10.0	9.5	9	ns	
tрцн	low-to-high Output	Alob	Open-drain Driving	181	170	154	115	
tpн∟	Propagation Delay Time	B to A	Push-pull Driving	7	7.1	7.2		
TIL	High-to-low Output	2 10 71	Open-drain Driving	7.6	8.1	9.2	ns	
t _{РLН}	Propagation Delay Time	B to A	Push-pull Driving	7.6	6.9	6	ns	
4FLN	low-to-high Output	D to /t	Open-drain Driving	163	145	118	110	
t _{en}	Enable Time		OE to A or B	135	159	182	ns	
t _{dis}	Disable Time		OE to A or B	170	174	181	ns	
+ -	Input Rise Time	A port	Push-pull Driving	13.4	11.9	10.6	no	
t _r A	Input Rise Time	rise time	Open-drain Driving	68	66	62	ns	
t _{rB}	Input Rise Time	B port	Push-pull Driving	13	12	11.6	ns	
чв	input ruse nine	rise time	Open-drain Driving	66	65	50	113	
t _{fA}	Input Fall Time	A port fall	Push-pull Driving	5.6	4.7	4.0	ns	
ца	mput ran rime	time	Open-drain Driving	5.0	5.1	5.2	113	
tns	Input Fall Time	B port fall	Push-pull Driving	3.0	3.0	2.9	ns	
чD	inputi an time	time	Open-drain Driving	6.1	5.6	4.4	110	
t _{sk(0)}	Skew(time), Output	Channel-to-Channel Skew		0.5	0.5	0.5	ns	
Ma	iximum Data Rate		Push-pull Driving	22	23	24	Mbps	
IVIC	Mindri Data Nato		Open-drain Driving	2	2	2	IVIDPS	



Switching Characteristics:Vcc=2.5V±0.15V

over operating free-air temperature range (unless otherwise noted)

	Parameter		Conditions	V _{ccB} =2.5V±0.2V	V _{ccB} =3.3V±0.2V	V _{ccB} =5V±0.2V	Units	
	Parameter		Conditions	Тур	Тур	Тур	Units	
t _{PHL}	Propagation Delay Time	A to B	Push-pull Driving	3.5	3.5	3.2	ns	
ΨHL.	High-to-low Output	Alob	Open-drain Driving	6.3	6.5	6.7	115	
	Propagation Delay Time	A to B	Push-pull Driving	4.5	4.9	4.7		
tрцн	low-to-high Output	AIOB	Open-drain Driving	158	152	142	ns	
t _{РНL}	Propagation Delay Time	B to A	Push-pull Driving	3.7	3.9	4.6		
UP FIL	High-to-low Output	BIOA	Open-drain Driving	6	6.6	7.7	ns	
tрцн	Propagation Delay Time	B to A	Push-pull Driving	4.8	4	2.5	ns	
(PLN	low-to-high Output	BIOA	Open-drain Driving	153	138	116	113	
t _{en}	Enable Time		OE to A or B	7.7	41.8	130	ns	
t _{dis}	Disable Time		OE to A or B	175	181	182	ns	
+.	Input Rise Time	A port	Push-pull Driving	9.8	8.6	7.5	ns	
t _r A	input Nise fillie	Rise Time	Open-drain Driving	79	77	65	115	
	Innut Dies Time	B port	Push-pull Driving	9.8	8.7	8.1		
trв	Input Rise Time	Rise Time	Open-drain Driving	93	68	53	ns	
4.	Input Fall Time	A port Fall	Push-pull Driving	4.6	4.1	3.6		
t _{fA}	Input Fall Time	Time	Open-drain Driving	5.1	5.1	5.2	ns	
tres	Input Fall Time	B port Fall	Push-pull Driving	4.5	4.0	4.0	ns	
uВ	input all tille	Time	Open-drain Driving	6.9	7.4	7.8	110	
tsĸ(o)	Skew(time), Output	Channel-to-Channel Skew		0.5	0.5	0.5	ns	
Ma	ximum Data Rate		Push-pull Driving	22	24	24	Mhne	
ivia	mini Data Nate		Open-drain Driving	2	2	2	Mbps	



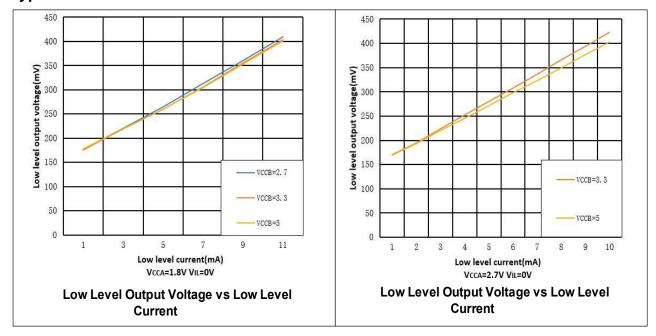
Switching Characteristics:Vcc=3.3V±0.15V

over recommended operating free-air temperature range (unless otherwise noted)

	Parameter		Conditions	V _{ccB} =3.3V±0.2V	V _{ccB} =5V±0.2V	Units
	Farameter		Conditions	TYP	TYP	Ullits
tрнц	Propagation Delay Time	A to B	Push-pull Driving	2.1	2.2	ns
LPHL	High-to-low Output	Alob	Open-drain Driving	5.9	6.1	115
	Propagation Delay Time	A	Push-pull Driving	1	3.3	
t _{PLH}	High-to-low Output	A to B	Open-drain Driving	138	131	ns
	Propagation Delay Time	B to A	Push-pull Driving	2.3	2.6	
t _{PHL}	High-to-low Output	D IO A	Open-drain Driving	5.4	6.6	ns
t _{РLН}	Propagation delay time	B to A	Push-pull Driving	1.0	1.0	ns
	low-to-high Output		Open-drain Driving	133	115	
t _{en}	Enable Time		OE to A or B	4.7	5.2	ns
t _{dis}	Disable Time		OE to A or B	174	182	ns
4.	Input Rise Time	A port	Push-pull Driving	7.4	6.6	ns
t _r A	input Nise Time	Rise Time	Open-drain Driving	75	67	113
t₁B	Input Rise Time	B port	Push-pull Driving	7.7	7.1	ns
urs .	input ruse rime	Rise Time	Open-drain Driving	70	65	113
tfA	Input Fall Time	A port Fall	Push-pull Driving	3.4	3.0	ns
цА	input raii riine	Time	Open-drain Driving	5.1	5.1	115
t _{fB}	Input Fall Time	B port Fall	Push-pull Driving	3.5	3.2	ns
UD .	input i all tillio	Time	Open-drain Driving	6.8	6.7	113
tsĸ(o)	Skew(time), Output	Cł	nannel-to-Channel Skew	0.5	0.5	ns
Maximum Data Rate		Push-pull Driving	24	24	Mbps	
			Open-drain Driving	2	2	MINHS



Typical Characteristics

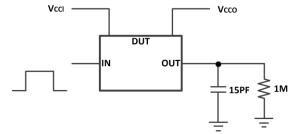


Parameter Measurement Information

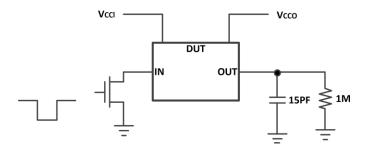
Unless otherwise noted, all input pulsed are supplied by generators having the following characteristics:

- PSRR 10MHz
- Zo=50 Ω
- dv/dt ≥1V/ns

Note: All input pulses are measured one at a time with one transition per measurement



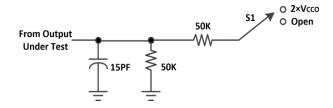
Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using a Push-Pull Driver



Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using an Open-Drain Driver



Parameter Measurement Information (Continued)

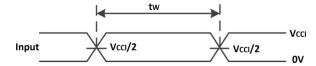


Load Circuit for Enable/Disable Time Measurement

Switch Configuration for Enable/Disable Timing

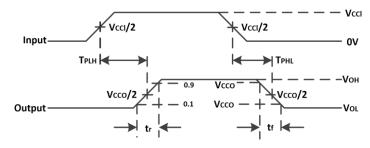
Test	S1
t _{PZL} ⁽¹⁾ , t _{PLZ} ⁽²⁾	2×Vcco
t _{РНZ} (1), t _{РZН} (2)	Open

- (1) t_{PZL} and t_{PZH} are the same as ten.
- (2) t_{PLZ} and t_{PHZ} are the same as tdis.

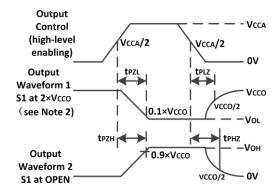


(1) All input pulses are measured one at a time, with one transition per measurement.

Voltage Waveforms Pulse Duration



Voltage Waveforms Propagation Delay Times



Voltage Waveforms Enable and Disable

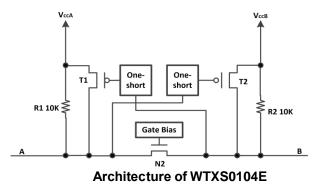


Overview

The WTXS0104E IC is a Bi-direction voltage-level translator specifically designed for translating logic voltage levels. The A port can accept I/O voltages that cover from 1.65 V to 3.6 V range; The B port can accept I/O voltages from 2.3 V to 5.5 V. The device is a pass-gate architecture with edge-rate accelerators (one-shots) to improve the overall data rate. $10\text{-k}\Omega$ pullup resistors that usually used in open-drain applications have been integrated inside IC with the advantage saving an external resistor. Not only the IC is designed for open-drain applications, but also this device can translate push-pull CMOS logic outputs.

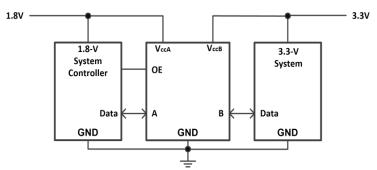
Architecture

The WTXS0104E architecture (see Figure below) is a translator with Bi-direction-Sensing function that means a direction-control mechanism to control the direction of data flow from A to B or from B to A is not needed. These two bidirectional channels independently determine the direction of data flow without a direction-control signal. This auto-direction feature is realized by each I/O pin can be automatically reconfigured as either an input or an output.



Application Information

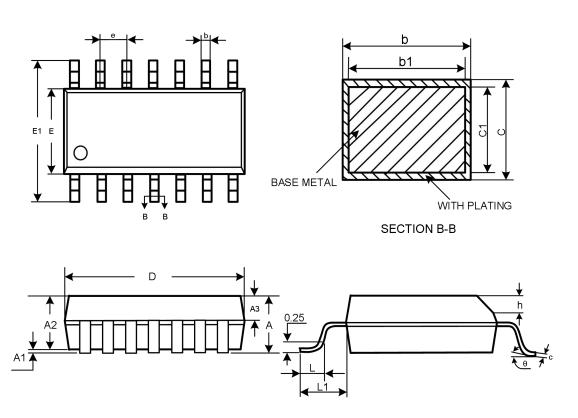
The WTXS0104E device can be used to bridge the digital-switching compatibility gap between two voltage nodes to successfully interface logic threshold levels found in electronic systems. It should be used in a point-to-point topology for interfacing devices or systems operating at different interface voltages with one another. Its primary target application use is for interfacing with open-drain drivers on the data I/Os such as I2C or 1-wire, where the data is bidirectional and no control signal is available. The device can also be used in applications where a push-pull driver is connected to the data I/Os, but the WTXS0108E might be a better option for such push-pull applications.



Typical Application Schematic



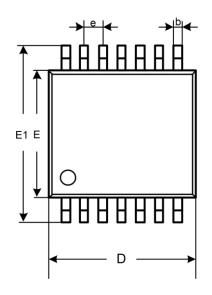
Package Outline Dimension SOP-14

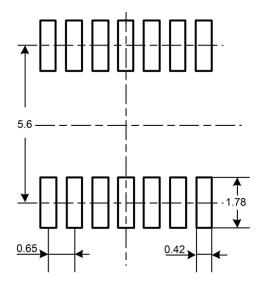


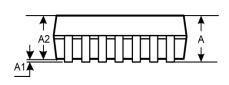
Symbol	Dimensions In Millimeters		Dimensions In Inches			
	Min	Nom	Max	Min	Nom	Max
Α	_	_	1.750	_	_	0.069
A1	0.100	_	0.225	0.004	_	0.009
A2	1.300	1.400	1.500	0.051	0.055	0.059
A3	0.600	0.650	0.700	0.024	0.026	0.028
b	0.390	_	0.470	0.015	_	0.019
b1	0.380	0.410	0.440	0.015	0.016	0.017
С	0.200	_	0.240	0.008	_	0.009
c1	0.190	0.200	0.210	0.007	0.008	0.008
D	8.550	8.650	8.750	0.337	0.341	0.344
E	5.800	6.000	6.200	0.228	0.236	0.244
E1	3.800	3.900	4.000	0.150	0.154	0.157
е	1.270BSC		0.05BSC			
h	0.250	_	0.500	0.010	_	0.020
L	0.500	_	0.800	0.020	_	0.031
L1	1.050REF		0.041REF			
θ	0°	_	8°	0°	_	8°



Package Outline Dimension TSSOP-14





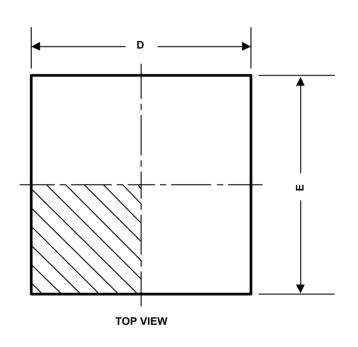


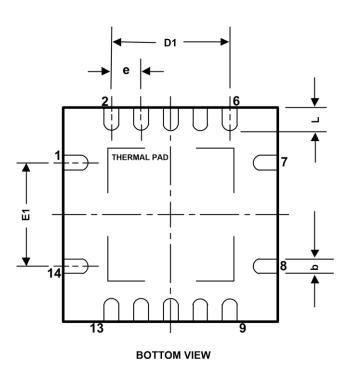


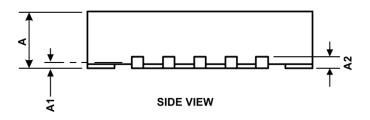
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Min
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
С	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
е	0.650BSC		0.026BSC	
L	0.500	0.700	0.020	0.028
Н	0.250TYP		0.010TYP	
θ	1°	7°	1°	7°



Package Outline Dimension QFN3.5×3.5-14L







Symbol	Dimensions In Millimeters		Dimensions In Inches			
	Min	Max	Min	Max		
A	0.800	1.000	0.031	0.039		
A1	0.000	0.050	0.00	0.002		
A2	0.2	0.200REF		0.008REF		
b	0.180	0.300	0.007	0.012		
D	3.350	3.650	0.132	0.144		
D1	2.0	2.000TYP		0.079TYP		
E	3.350	3.650	0.007	0.012		
E1	1.500TYP		0.059TYP			
е	0.500TYP		0.020TYP			
L	0.300	0.500	0.012	0.020		



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